

SZMD12C

150W, 12 V

Transient Voltage Suppressors for ESD Protection

SOT-23

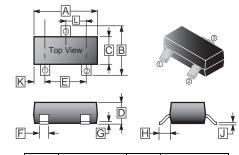
RoHS Compliant Product
A suffix of "-C" specifies halogen & lead-free

FEATURES

- SOT-23 package for surface mount application
- Protects 12V components
- Protects two unidirectional line or one bi-direction line
- Provides electrically is olated protection

APPLICATIONS

- Cellular Handsets and Accessories
- Portable devices
- Industrial Controls
- Set -Top Box
- · Servers, Notebook, and Desktop PC



REF.	Millimeter		REF.	Millimeter		
	Min.	Max.	KLI.	Min.	Max.	
Α	2.80	3.00	G	0.10 REF.		
В	2.25	2.55	Н	0.55 REF.		
С	1.20	1.40	J	0.08	0.15	
D	0.90	1.15	K	0.5 REF.		
Е	1.80	2.00	L	0.95 TYP.		
F	0.30	0.50	_			

Marking Code

KDJ

ABSOLUTE RATINGS (Tamb = 25°C)

R	Symbol	Value	Units	
IEC 61000-4-2 (ESD)	Air contact		±15	kV
	Contact discharge		±8	kV
ESD voltage	Per human body model		16	kV
Total power dissipation on FR-5	P_{D}	150	m/W	
Junction and storage temperatu	re range	T_J, T_STG	-55 ~ +150	°C
Lead solder temperature – maxi	T_L	260	°C	

Stresses exceeding Maximum Ratings may damage the device. Maximum Rating are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability. 1. FR-5 = 1.0*0.75*0.62 in.

ELECTRICAL CHARACTERISTICS

(Ratings at 25°C ambient temperature unless otherwise specified. $V_F = 0.9V$ at $I_F = 10mA$)

<u> </u>								
Device	V _{RWM} (V)	I _R (uA) @ V _{RWM}	V _{BR} (V) @ I _T (Note 2)	I _T (mA)	V _C (V) @ Max I _{PP} (Note 3)	I _{PP} (A) (Note 3)	P _{PK} (W)*	C (pF) (Note 4)
	Max	Max	Min	mA	Max	Max	Max	Тур
SZMD12C	12	0.1	13.8	5.0	25.0	8.0	150	50

Other voltages available upon request.

- 3. Surge current waveform per Figure 3.

4. Measured at 1MHz 0V.

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Any changes of specification will not be informed individually

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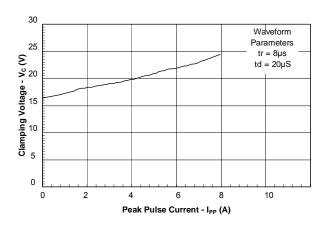
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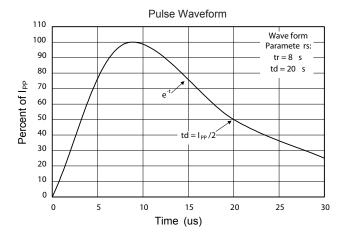
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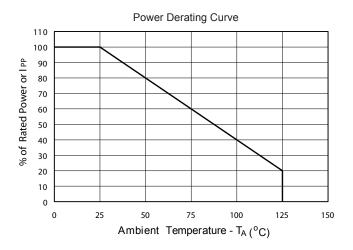
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RATINGS AND CHARACTERISTICS CURVES

Clamping Voltage vs. Peak Pulse Current







Applications Information

Device Connection Options

The SZMD series is designed to protect one bi-directional or two uni-directional data or I/O lines operating at 12 volts. Connection options are as follows:

· Bidirectional:Pin 1 is connected to the data line and pin 2 is connected to ground (Since the device IIs symmetrical, these conmtions may be re- Ver3ed). For best results, the ground connection should be made directly to a ground plane on the board. The path length should be kept as short as possible to minimize parasitic inductance-Pin 3 is not connected. • Unidirectional:Data lines are connected to pin1 and pin2.Pin 3 is connected to ground.For best results, this pin should be connected directly to a ground plane on the board. The path lengh should be kept as short as possible to minimize parasitic inductance. Circuit Board Layout Recommendations for suppres- sion of ESD. Good circuit board layout is critical for the suppression of fast rise-time transients such as ESD. The following guidelines are recommended (Refer to application note SI99.01 for more detailed information): • Place the TVS near the input terminals or connectors to restrict transient coupling. • Minimize the path length between the TVS and the protected line. • Minimize all conductive loops including power and ground loops. • The ESD transient return path toground should be kept as short as possible. • Never run critical signals near board edges

· Use ground planes whenever possible.

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